



Product Change Notification

106849 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 106849 - 00
Change Title: SE7221BK1, SE7221BK1LX, BBKBB and BBKBBLX, PCN 106849-00, Product Material, Class 2, System Board update from FAB 5 to Fab 6 for chemical change from immerision silver to HASL for RoHS.
Date of Publication: October 05, 2006

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Nov 02, 2006
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Description of Change to the Customer:

The FAB 5 version of Intel(r) server board SE7221BK1 and SE7221BK1LX were manufactured as immersion silver process for surface component solder. The Fab 6 baseboard has been corrected to the HASL type solder process for RoHS. This is the same solder process as used on the previous Fab 4 RoHS compliante server boards.

Customer Impact of Change and Recommended Action:

Evaluate when recieved

Products Affected / Intel Ordering Codes:

Pre Change Product Code	Pre Change MM#	Pre Change TA	Pre Change PBA	Post Change MM#	Post Change TA	Post Change PBA
SE7221BK1	878684	D36735-003	C67508-550	878684	D36735-004	C67508-650
SE7221BK1LX	878685	D36708-003	C78048-550	878685	D36708-004	C78048-650
BBKBBLX	881919	C81523-550	C78048-550	881919	C81523-550	C78048-650
BBKBB	881923	C81521-550	C67508-550	881923	C81521-650	C67508-650

Reference Documents / Attachments:

Document: _____ **Location #:** _____

PCN Revision History:

Date of Revision: October 5, 2006	Revision Number: 00	Reason: Originally Published PCN
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